

(3.81 mm) .150"

UPS SERIES

. LEAF 20 A POWER SOCKET

SPECIFICATIONS

For complete specifications see www.samtec.com?UPS

Insulator Material: Black LCP

Contact Material: BeCu

Plating:

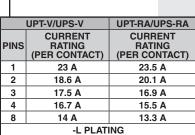
Sn or Au over 50 μ" (1.27 um) Ni

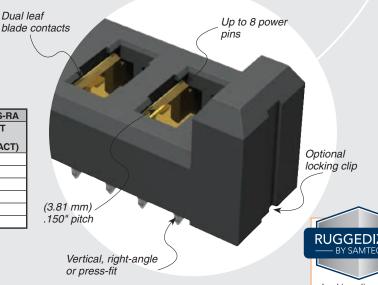
Operating Temp Range: -55 °C to +105 °C with Tin; -55 °C to +125 °C with Gold Voltage Rating: 438 VAC/620 VDC

Standard Creepage: (5.8 mm) .228" (with -V) (2.97 mm) .117" (with -RA) Standard Clearance: (1.51 mm) .059" **RoHS Compliant:**

Lead-Free Solderable:

Mates with:





RUGGEDIZED

Locking clip option

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



CREEPAGE **CLEARANCE**



Selectively loading contacts achieves customer specific creepage and clearance requirements. Contact asp@samtec.com

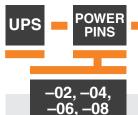
ALSO AVAILABLE (MOQ Required)

· Solder leads for (2.36 mm) .093" thick board

TOOLING

Press-fit tooling available.

Some sizes, styles and options are non-standard, non-returnable.



LEAD	

LEAD STYLE	Α	В
-04.0	(3.75) .148	(6.75) .266
-07.0	(6.75) .266	(9.75) .384

No. of power pins x (3.81) .150 + (6.76) .266

← (3.81) - .150

→ (0.30) - 012

В

Α

(1.00) ⊢.039 DIA

(2.00) .0787

(1.50)

.059

(5.00)

.197

(1.25 .049

LEAD **STYLE**

-01= RA only

-04.0= (04.0 mm) .157" (-V & -PV only)

-07.0 = (07.0 mm) .276" (-V & -PV only)

TAIL LENGTH

-01 = Use with (1.60 mm) .062' Thick PCB (–V & –RA only)

-03= Use with (1.60 mm) .062' Thick PCB (-PV only)

(2.20) .087

PLATING OPTION

= 10 µ" (0.25 µm) Gold on contact, Matte Tin

= Matte Tin (-RA option only)

on tail

TAIL

= Vertical (Not available with -T plating)

–RA = Rightangle

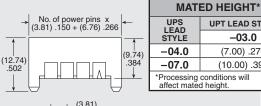
-PV = Press Vertical

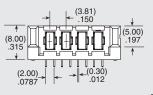
= Locking Clip (Manual placement required) Not available with -PV option

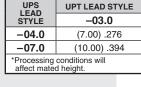
OTHER

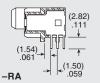
OPTION

–LC









-PV